**Board Name:** USB Type-C HDD with Power Delivery

**Layer Description:** All artwork layers viewed from top

**Board Rev:** 1.0  
**KSID:** 16439  
**Job Number:** 127668
BOARD NAME: USB TYPE-C HDD WITH POWER DELIVERY

ALL ARTWORK LAYERS VIEWED FROM TOP

BOARD REV: 1.0
KSID: 16439
JOB NUMBER: 127668

LAYER DESCRIPTION: SOLDERMASK BOTTOM
FOR EVALUATION ONLY:
NOT FCC APPROVED FOR RESALE

BOARD NAME:
USB TYPE-C HDD WITH POWER DELIVERY

LAYER DESCRIPTION:
SILKSCREEN BOTTOM
BOARD NAME: USB TYPE-C HDD WITH POWER DELIVERY

BOARD REV: 1.0
KSID: 16439
JOB NUMBER: 127668

ALL ARTWORK LAYERS VIEWED FROM TOP

LAYER DESCRIPTION:
PASTEMASK BOTTOM

KSID: XXXXXXXXXX
BOARD NAME: USB TYPE-C HDD WITH POWER DELIVERY

ALL ARTWORK LAYERS VIEWED FROM TOP

LAYER DESCRIPTION: LAYER 2 - GND PLANE
USB TYPE-C HDD WITH POWER DELIVERY

ALL ARTWORK LAYERS VIEWED FROM TOP

Layer Description:
XXXXX

Board Name:
USB TYPE-C HDD WITH POWER DELIVERY

Board Rev:
1.0

KSID:
16439

Job Number:
127668
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